High Power Resistive Products

Terminations

AVX introduces its complete line of High Power Termination Products. All Products are designed and manufactured at our ISO 9001 Facilities.

ELECTRICAL SPECIFICATIONS

Resistance: 50 Ω standard (10 Ω - 200 Ω available) **Resistance Tolerance:** $\pm 5\%$ standard ($\pm 2\%$ available)

Power: 2 Watts through 225 Watts

Operating Temperature Range: -55°C to +150°C

Temperature Coefficient: < 150 ppm/°C

Low VSWR



Package: Surface Mount Chips, Chips, Leaded Chips,

Flange Mount

Substrate Material: Aluminum Nitride

Process: Thin Film

Resistive Material: Tantalum

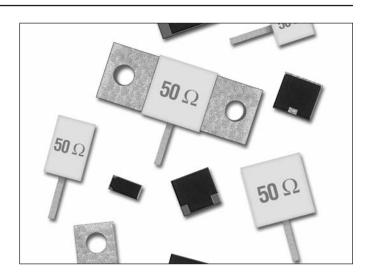
Terminals: Silver **Cover:** Alumina

Mounting Flange: 100% Cu, Ni or Ag Plated

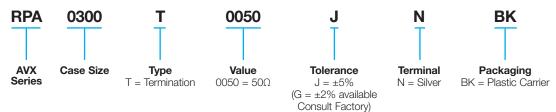
Mechanical Tolerance: ±0.13 (0.005)

RoHS Compliant

SMT and Chip products, supplied on Tape and Reel

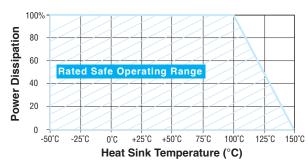


FLANGE MOUNT TERMINATIONS HOW TO ORDER



Contact factory for custom ratings and sizes.

POWER DERATING





High Power Resistive Products



Terminations

LEADED CHIP TERMINATIONS - RPB SERIES

GENERAL SPECIFICATIONS

Nominal Impedance: 50 Ω

Resistive Tolerance: ±5% standard, ±2% available

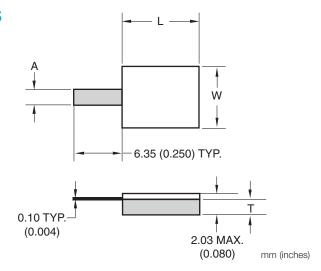
Operating Temp Range: -55°C to +150°C Temperature Coefficient: ±150 ppm/°C

Resistive Elements: Tantalum, Thin Film Processed

Substrate Material: Aluminum Nitride

Terminals: Silver over Nickel

RoHS Compliant



mm (inches)

AVX Part Number	W ±0.25 (0.010)	L ±0.25 (0.010)	T ±0.13 (0.005)	A ±0.13 (0.005)	Frequency (GHz)	Capacitance (pF)	Power Max** (Watts)
RPB1020T0050JTTR	5.08 (0.200)	2.54 (0.100)	0.64 (0.025)	1.02 (0.040)	DC to 18.0	1.25:1	20W
RPB2010T0050JTTR	2.54 (0.100)	5.08 (0.200)	1.02 (0.040)	1.02 (0.040)	DC to 4.0	1.20:1	30W
RPB2525T0050JTTR	6.22 (0.245)	6.22 (0.245)	1.02 (0.040)	1.02 (0.040)	DC to 4.0	1.15:1	60W
RPB2335T0050JTTR	8.89 (0.350)	5.84 (0.230)	1.02 (0.040)	1.02 (0.040)	DC to 4.0	1.15:1	100W
RPB3725T0050JTTR	6.35 (0.250)	9.53 (0.375)	1.02 (0.040)	1.02 (0.040)	DC to 4.0	1.20:1	125W
RPB3737T0050JTTR	9.40 (0.370)	9.40 (0.370)	1.02 (0.040)	1.02 (0.040)	DC to 2.0	1.25:1	200W

^{**} Test Condition: Chip soldered to a via patch on a 30-mil-thick Rogers RO4350 board; Land surfaces at 100°C; maximum rated power applied.

HOW TO ORDER



Contact factory for custom ratings and sizes.

POWER DERATING

